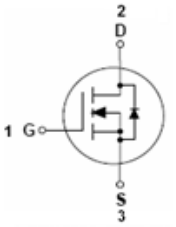
N-Channel Enhancement Mode MOSFET

TBL02N10C

Features

- Electrostatic sensitive devices
- Excellent package for good heat dissipation
- Halogen free
- Qualified to AEC-Q101 standards for high reliability

HF

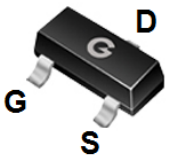


APPLICATIONS

- Power switching application
- Hard switching and high frequency circuits
- Uninterruptible power supply

Mechanical Data

- Case: SOT-23
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208



SOT-23

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
TBL02N10C	SOT-23	3000 pcs / Tape & Reel	2N10

Maximum Ratings (@ T_A = 25℃ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	V_{DSS}	100	V
Gate-to-Source Voltage	V_{GSS}	±20	V
Continuous Drain Current	I_D	2	A
Pulsed Drain Current *2	I_{DM}	5	A

Thermal Characteristics

Parameter	Symbol	Value	Unit
Power Dissipation	P_D	0.35	W
Thermal Resistance Junction-to-Air *1	$R_{\theta JA}$	357	°C/W
Thermal Resistance Junction-to-Lead *1	$R_{\theta JL}$	214	°C/W
Thermal Resistance Junction-to-Case *1	$R_{\theta JC}$	180	°C/W
Operating Junction Temperature Range	T_J	-55 ~ +150	°C
Storage Temperature Range	T_{STG}	-55 ~ +150	°C

Electrical Characteristics (@ T_A = 25℃ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
V_{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = 250μA	100	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 100V, V_{GS} = 0V	-	-	1	μA
I_{GSS}	Gate-Body Leakage Current	V_{GS} = ±20V, V_{DS} = 0V	-	-	±100	nA
On Characteristics						
$R_{DS(ON)}$	Static Drain-Source On-resistance *2	V_{GS} = 10V,I_D = 2A	-	0.204	0.24	Ω
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250μA	1	2.1	2.5	V
g_{FS}	Forward Transconductance	V_{DS} = 5V, I_D = 2.9A	-	-	1.2	S
Dynamic Characteristics						
C_{ISS}	Input Capacitance	V_{GS} = 0V V_{DS} = 25V f = 1.0MHz	-	392	-	pF
C_{OSS}	Output Capacitance		-	24	-	
C_{RSS}	Reverse Transfer Capacitance		-	14	-	
Switching Characteristics						
$t_{d(ON)}$	Turn-on Delay Time	V_{DD} = 30V, V_{GS} = 10V R_G = 2.5Ω, R_L = 15Ω I_D = 2A	-	11	-	ns
t_r	Turn-on Rise Time		-	7.4	-	
$t_{d(OFF)}$	Turn-Off Delay Time		-	35	-	
t_f	Turn-Off Fall Time		-	9.1	-	
Q_G	Total Gate-Charge	V_{DD} = 30V V_{GS} = 10V I_D = 2A	-	12	-	nC
Q_{GS}	Gate to Source Charge		-	3	-	
Q_{GD}	Gate to Drain (Miller) Charge		-	1.6	-	
Source-Drain Diode Characteristics						
V_{SD}	Diode Forward Voltage *2	I_{SD} = 2A, V_{GS} = 0V, T_J = 25°C	-	-	1.2	V

Notes:

1. Device mounted on FR-4 PCB
2. The data tested by pulsed, pulse width ≤ 300μs, duty cycle ≤ 2%

Ratings and Characteristics Curves (@ T_A = 25°C unless otherwise specified)

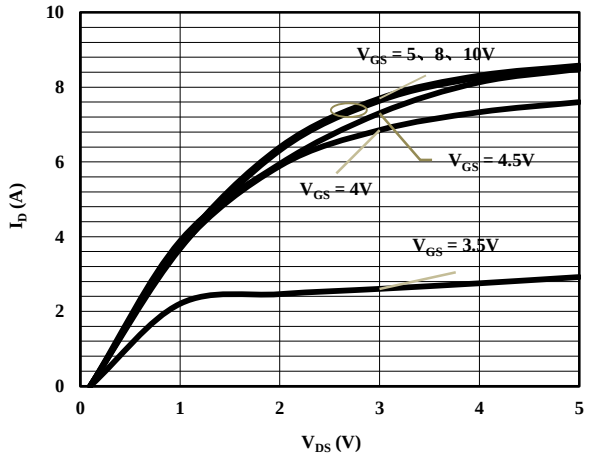


Fig 1 On-Region Characteristics

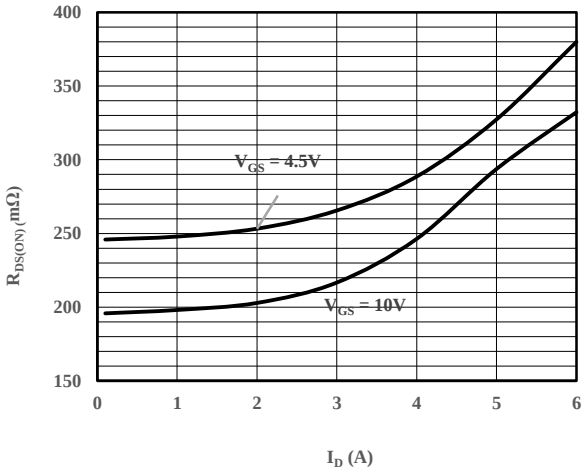


Fig 2 On-Resistance vs. Drain Current and Gate Voltage

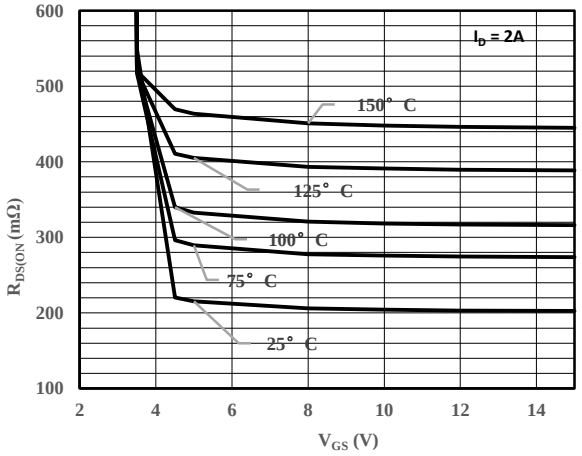


Fig 3 On-Resistance vs. Gate-Source Voltage

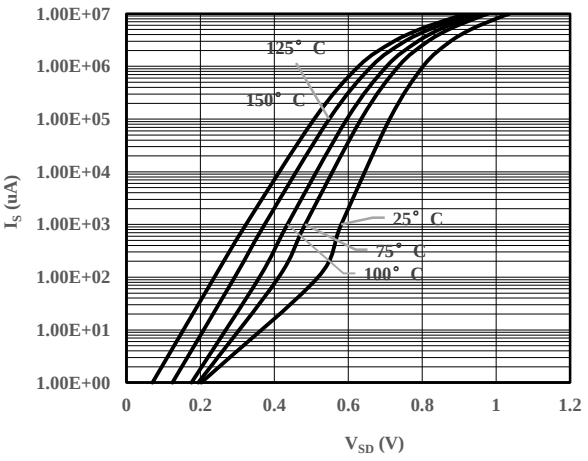


Fig 4 Body-Diode Characteristics

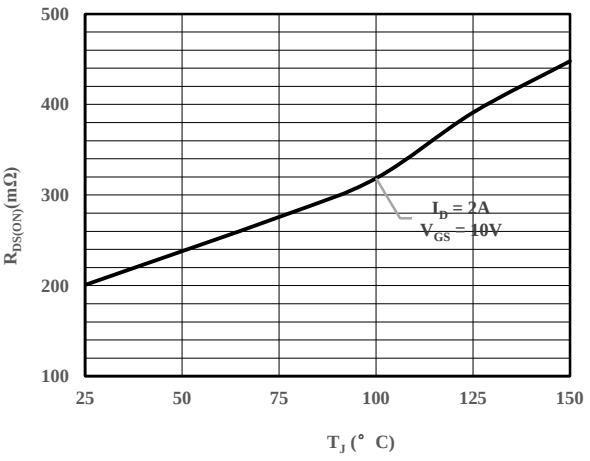


Fig 5 On-Resistance vs. Junction Temperature

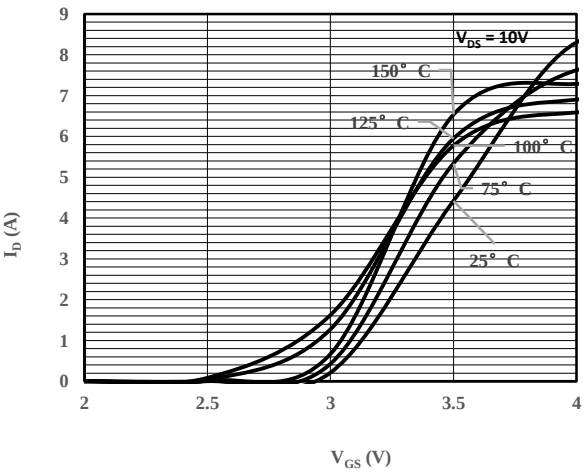


Fig 6 Transfer Characteristics

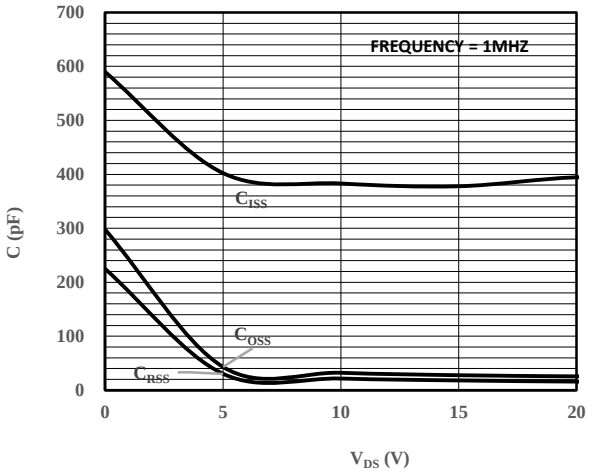


Fig 7 Capacitance Characteristics

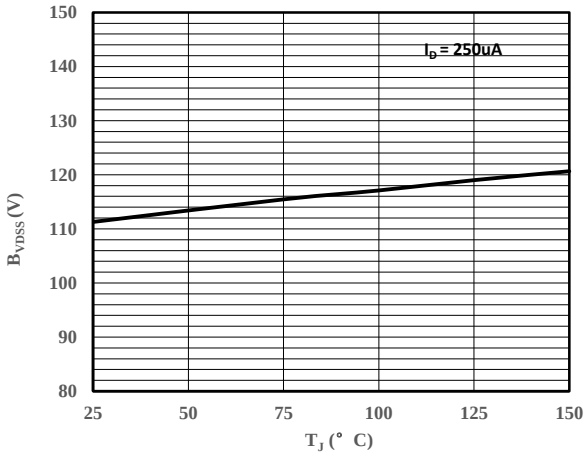


Fig 8 Drain-Source vs. Junction Temperature

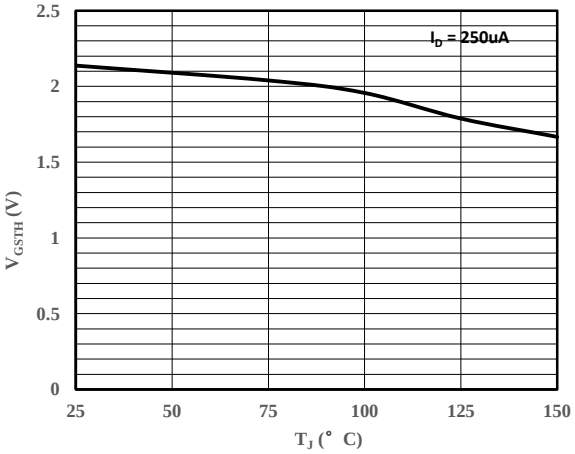
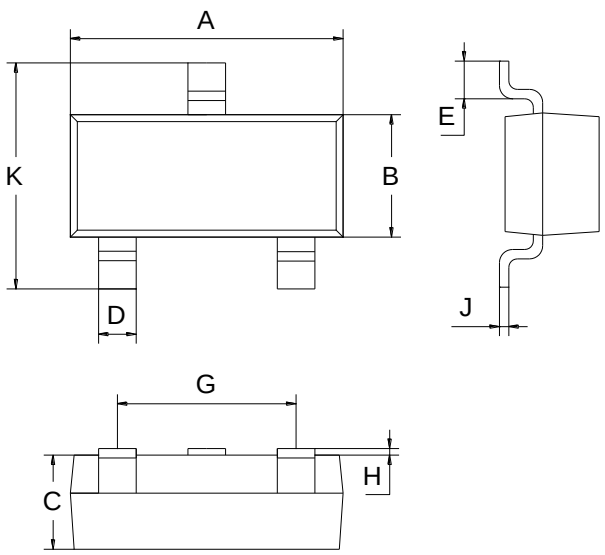


Fig 9 Gate Voltage vs. Junction Temperature

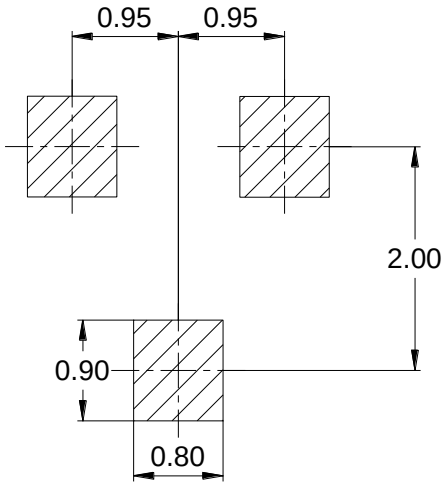
Package Outline Dimensions (Unit: mm)



SOT-23		
Dimension	**Min.**	**Max.**
A	2.70	3.10
B	1.10	1.50
C	0.90	1.10
D	0.30	0.50
E	0.35	0.48
G	1.80	2.00
H	0.02	0.10
J	0.05	0.15
K	2.20	2.60

Mounting Pad Layout (Unit: mm)

SOT-23



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